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FDMS7660 N-Channel PowerTrench[®] MOSFET 30 V, 2.8 m Ω

Features

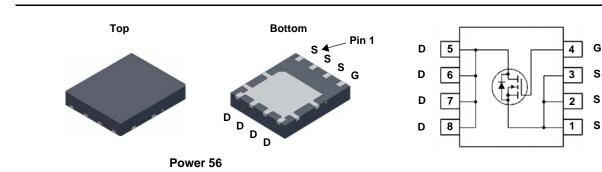
- Max r_{DS(on)} = 2.8 mΩ at V_{GS} = 10 V, I_D = 25 A
- Max $r_{DS(on)}$ = 3.5 m Ω at V_{GS} = 4.5 V, I_D = 19 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery. Provides Schottky-like performance with minimum EMI in sync buck converter applications
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed and body diode reverse recovery performance.

Applications

- IMVP Vcore Switching for Notebook
- VRM Vcore Switching for Desktop and Server
- OringFET / Load Switch
- DC-DC Conversion



MOSFET Maximum Ratings $T_A = 25 \degree C$ unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
I _D	Drain Current -Continuous (Package limited)	T _C = 25 °C		42		
	-Continuous (Silicon limited)	T _C = 25 °C		144	Α	
	-Continuous	T _A = 25 °C	(Note 1a)	25		
	-Pulsed			150		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	128	mJ	
P _D	Power Dissipation	T _C = 25 °C		78	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	
Thermal Ch	naracteristics					
$R_{\theta JC}$	Thermal Resistance, Junction to Case			1.6	°C/W	
					- C/VV	

RejA Thermal Resistance, Junction to Ambient (Note 1a) 50

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7660	FDMS7660	Power 56	13 "	12 mm	3000 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, V_{GS} = 0 \ V$	30			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		17		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			1	μΑ	
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.25	1.9	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-7		mV/°C	
	Static Drain to Source On Resistance	V _{GS} = 10 V , I _D = 25 A		1.9	2.8	1	
r _{DS(on)}		$V_{GS} = 4.5 \text{ V}, I_{D} = 19 \text{ A}$		2.7	3.5	mΩ	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 25 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		2.5	3.7		
9 _{FS}	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 25 \text{ A}$		250		S	
Dynamic	Characteristics						
C _{iss}	Input Capacitance			4185	5565	pF	
C _{oss}	Output Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		1380	1830	pF	
C _{rss}	Reverse Transfer Capacitance			125	190	pF	
R _g	Gate Resistance			0.9	2.0	Ω	
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time	_		17	31	ns	
t _r	Rise Time	V _{DD} = 15 V, I _D = 25A,		9	18	ns	
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		37	60	ns	
t _f	Fall Time			7	13	ns	
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		60	84	nC	
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 15 V,$		27	38	nC	
Q _{gs}	Gate to Source Charge	I _D = 25 A		12.3		nC	
Q _{gd}	Gate to Drain "Miller" Charge			7.2		nC	
Drain-Sou	urce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2.1 A$ (Note 2)		0.7	0.95	V	
		$V_{GS} = 0 V, I_S = 25 A$ (Note 2)		0.8	1.1		
t _{rr}	Reverse Recovery Time			46	74	ns	
Q _{rr}	Reverse Recovery Charge			26	42	nC	
t _a	Reverse Recovery Fall Time	I _F = 25 A, di/dt = 100 A/μs		19		nC	
t _b	Reverse Recovery Rise Time			27		nC	
S	Softness (t _b /t _a)			1.4			
t _{rr}	Reverse Recovery Time	– I _F = 25 A, di/dt = 300 A/μs		36	58	ns	
Q _{rr}	Reverse Recovery Charge	$ F - 2070, a, a = 00070 \mu 3$		43	68	nC	



2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

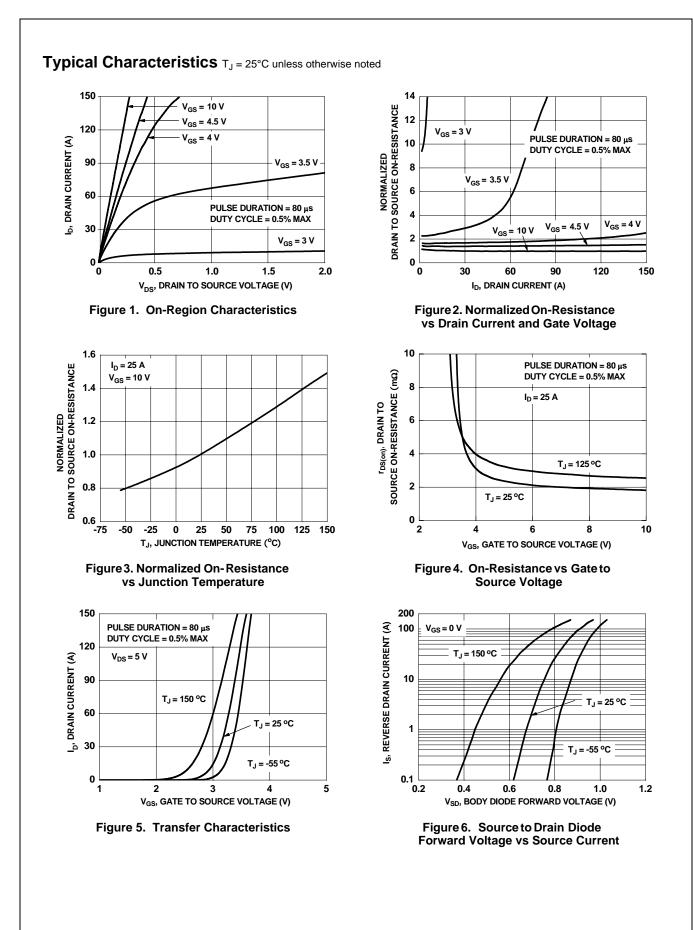
3. E_{AS} of 128 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 16 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 23 A.

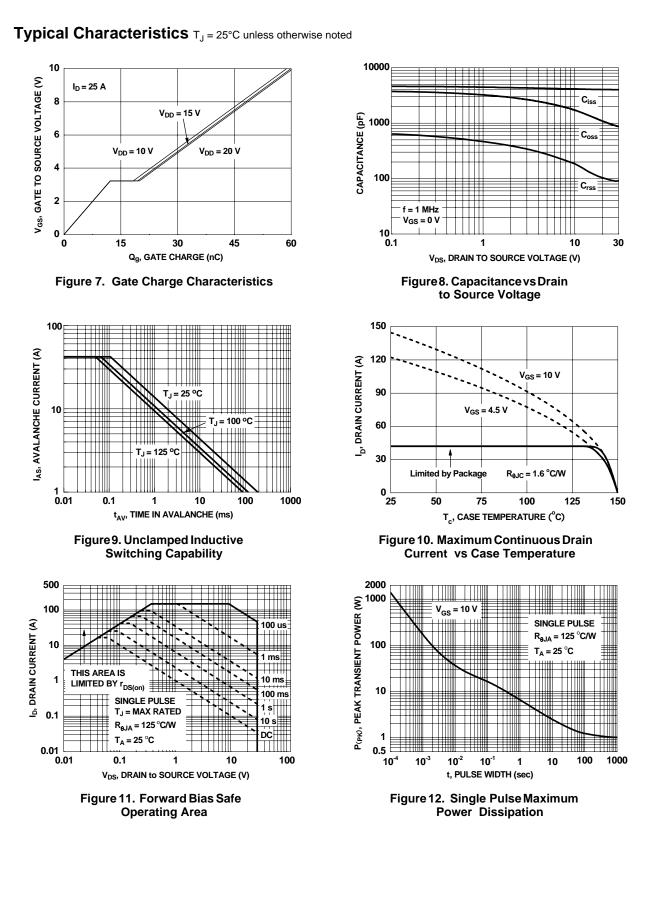
As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.
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 FDMS7660 Rev. D
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b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

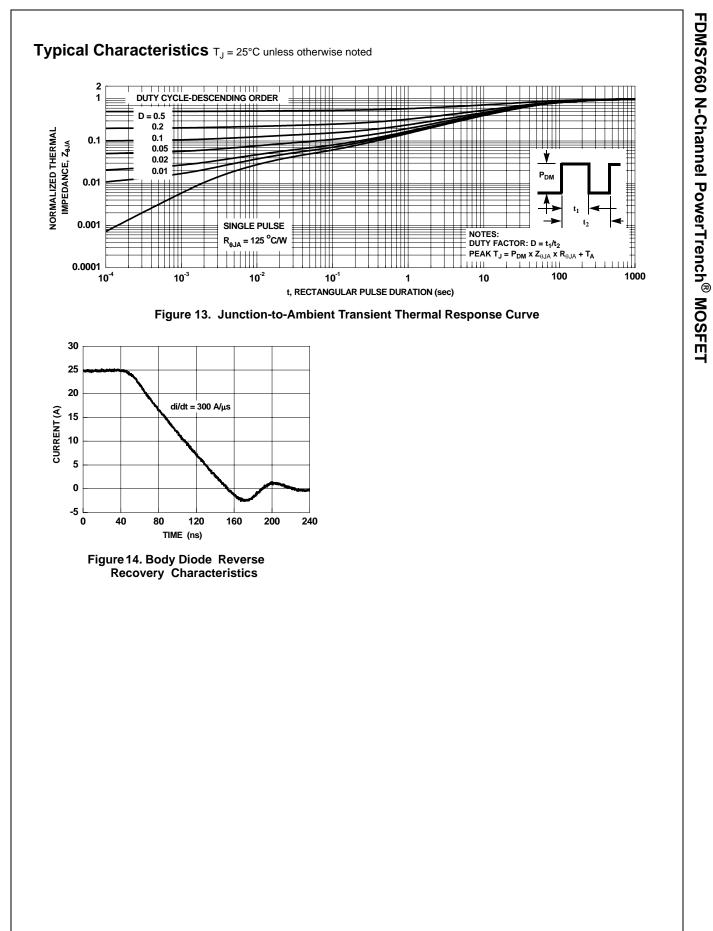
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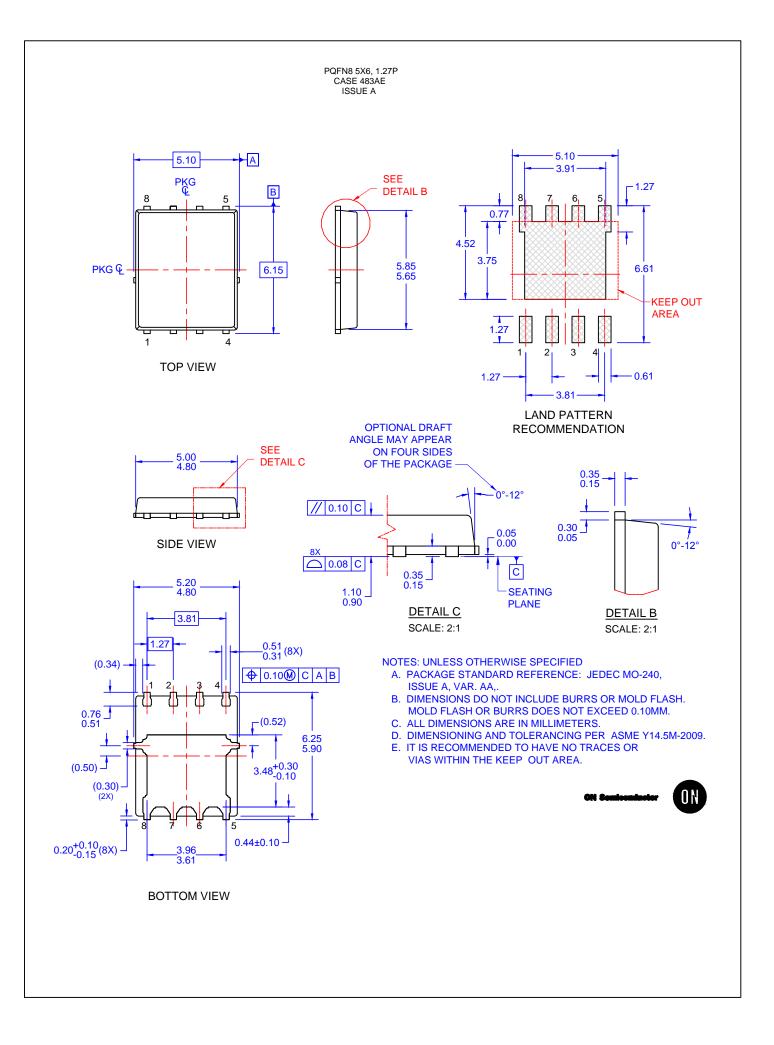
a. 50 °C/W when mounted on a 1 in² pad of 2 oz copper.





FDMS7660 N-Channel PowerTrench[®] MOSFET





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